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Vishay/Siliconix IRFR010

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Datasheet of IRFR010 - MOSFET N-CH 50V 8.2A DPAK

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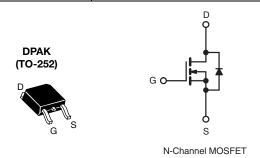
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IRFR010, SiHFR010

Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	50	50				
R _{DS(on)} (Ω)	V _{GS} = 10 V	0.20				
Q _g (Max.) (nC)	10)				
Q _{gs} (nC)	2.6	2.6				
Q _{gd} (nC)	4.8	4.8				
Configuration	Sing	Single				



FEATURES

- Low Drive Current
- Surface Mount
- Fast Switching
- Ease of Paralleling
- Excellent Temperature Stability
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

The power MOSFET technology is the key to Vishay's advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the design achieves: very low on-state resistance combined with high transconductance; superior reverse energy and diode recovery dV/dt capability.

The power MOSFET transistors also feature all of the well established advantages of MOSFET'S such as voltage control, very fast switching, ease of paralleling and temperature stability of the electrical parameters.

Surface mount packages enhance circuit performance by reducing stray inductances and capacitance. The DPAK (TO-252) surface mount package brings the advantages of power MOSFET's to high volume applications where PC Board surface mounting is desirable. The surface mount option IRFR9012, SiHFR9012 is provided on 16 mm tape. The straight lead option IRFU9012, SiHFU9012 of the device is called the IPAK (TO-251).

They are well suited for applications where limited heat dissipation is required such as, computers and peripherals, telecommunication equipment, dc-to-dc converters, and a wide range of consumer products.

ORDERING INFORMATION			
Package	DPAK (TO-252)		
Lead (Pb)-free	IRFR010PbF		
Lead (FD)-iree	SiHFR010-E3		

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, uni	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	50		
Gate-Source Voltage			V_{GS}	± 20	- V	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	- I _D	8.2	A	
Continuous Diain Current	V _{GS} at 10 V	T _C = 100 °C		5.2		
Pulsed Drain Current ^a			I _{DM}	33		
Avalanche Current ^b			I _{AS}	1.5		
Linear Derating Factor				0.20	W/°C	
Maximum Power Dissipation	T _C = 25 °C		P_{D}	25	W	
Peak Diode Recovery dV/dtc			dV/dt	2.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)d	for 10 s			300	7	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD}=25$ V, starting $T_J=25$ °C, L=100 μH , $R_g=25$ Ω . c. $I_{SD}\leq 8.2$ A, $dI/dt\leq 130$ A/ μs , $V_{DD}\leq 40$ V, $T_J\leq 150$ °C.
- 1.6 mm from case.
- When mounted on 1" square PCB (FR-4 or G-10 material).

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	-	110	
Case-to-Sink	R _{thCS}	-	1.7	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	5.0]

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•					
Drain-Source Breakdown Voltage	V_{DS}	V _{GS} = 0 V, I _D = 250 μA		50	-	-	٧
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 500	nA
Zava Cata Valtaga Dvaig Cuwant	1	V _{DS} = 50 V, V _{GS} = 0 V		-	-	250	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	1000	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 4.6 A ^b	-	0.16	0.20	Ω
Forward Transconductance	9fs	V _{DS}	≥ 50 V, I _D = 3.6 A	2.1	3.1	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	250	-	pF
Output Capacitance	C _{oss}		$V_{DS} = 25 \text{ V},$	-	150	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 10	-	29	-	
Total Gate Charge	Qg			-	6.7	10	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 7.3 \text{ A}, V_{DS} = 40 \text{ V},$ see fig. 6 and 13 ^b	-	1.8	2.6	
Gate-Drain Charge	Q _{gd}	7	occ ng. o and 10	-	3.2	4.8	
Turn-On Delay Time	t _{d(on)}			-	11	17	ns ns
Rise Time	t _r	V _{DD} :	V _{DD} = 25 V, I _D = 7.3 A,		33	50	
Turn-Off Delay Time	t _{d(off)}	$R_g = 24 \Omega$, $R_D = 3.3 \Omega$, see fig. 10^b		-	12	18	
Fall Time	t _f			-	23	35	
Internal Drain Inductance	L _D	6 mm (0.25")	Between lead, 6 mm (0.25") from			-	nH
Internal Source Inductance	L _S	package and center of die contact ^c		-	7.5	-	1111
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8.2	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	33	
Body Diode Voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 8.2 \text{A}, V_{GS} = 0 \text{V}^{\text{b}}$		_	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 7.3 \text{A}, \text{dI/dt} = 100 \text{A/µs}^{\text{b}}$		41	86	190	ns
Body Diode Reverse Recovery Charge	Q _{rr}	1J = 25 C, IF	0.15	0.33	0.78	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

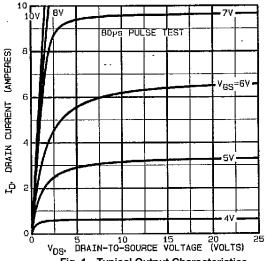


Fig. 1 - Typical Output Characteristics

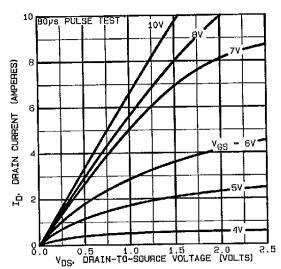


Fig. 2 - Typical Output Characteristics

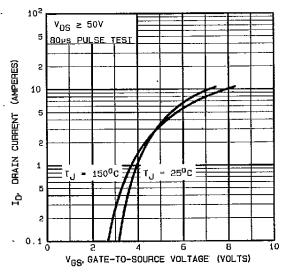


Fig. 3 - Typical Transfer Characteristics

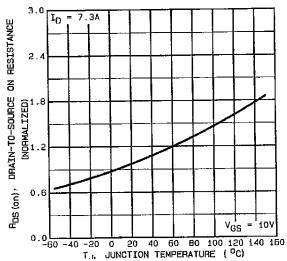


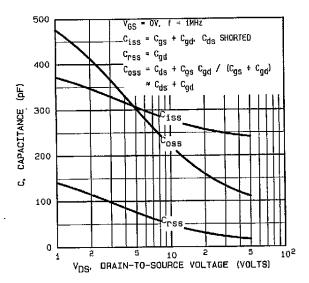
Fig. 4 - Normalized On-Resistance vs. Temperature



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Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

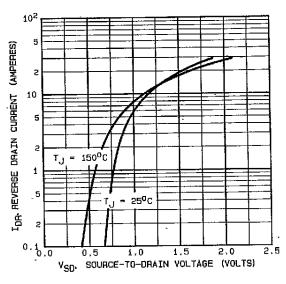


Fig. 7 - Typical Source-Drain Diode Forward Voltage

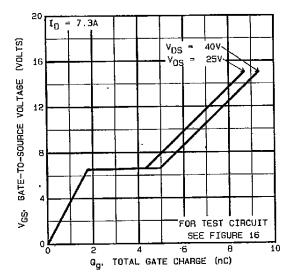


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

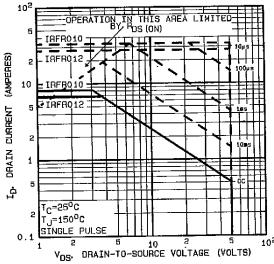


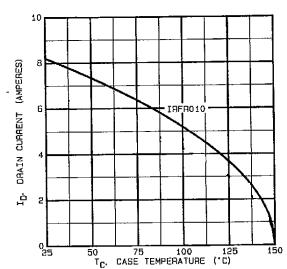
Fig. 8 - Maximum Safe Operating Area





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Fig. 9 - Maximum Drain Current vs. Case Temperature

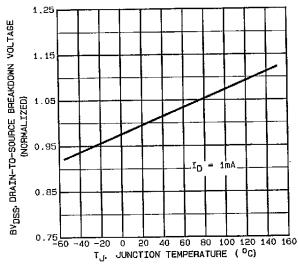


Fig. 10 - Breakdown Voltage vs. Temperature

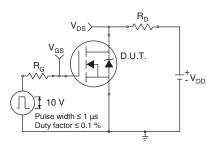


Fig. 10a - Switching Time Test Circuit

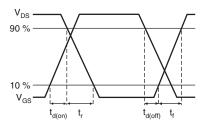


Fig. 10b - Switching Time Waveforms

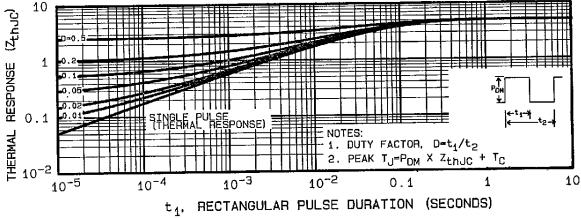


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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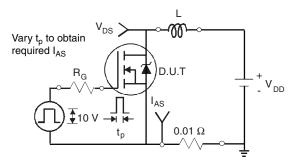


Fig. 12a - Unclamped Inductive Test Circuit

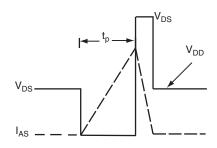


Fig. 12b - Unclamped Inductive Waveforms

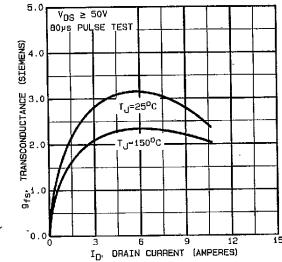


Fig. 12c - Typical Transconductance vs. Drain Current

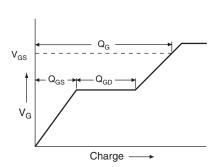


Fig. 13a - Basic Gate Charge Waveform

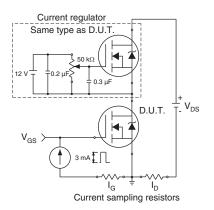


Fig. 13b - Gate Charge Test Circuit

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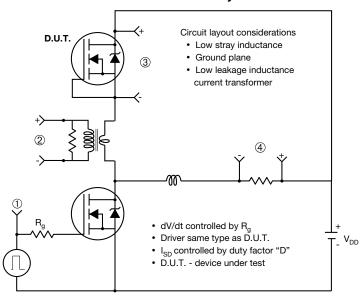
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Peak Diode Recovery dV/dt Test Circuit



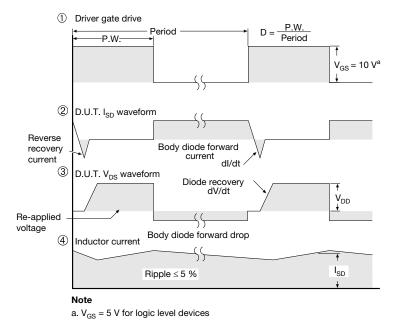


Fig. 14 - For N-Channel

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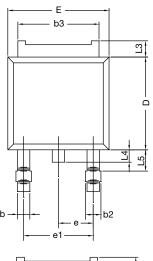


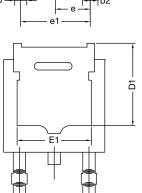
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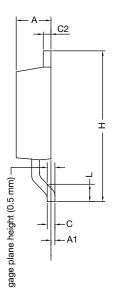
Package Information

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TO-252AA Case Outline







	MILLIN	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	ı	0.170	-	
Η	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56	BSC	0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16 DWG: 5347					

Notes

• Dimension L3 is for reference only.

Revision: 16-May-16 Document Number: 71197



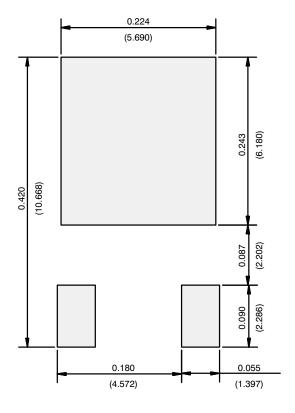




Application Note 826

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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